



# BCP54T-Q series

45 V, 1 A NPN medium power transistors

Rev. 1 — 14 November 2025

Product data sheet

## 1. General description

NPN medium power transistors in a medium power SOT223 (SC73) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		PNP complement
	Nexperia	JEDEC	
BCP54T-Q	SOT223	SC-73	BCP51T-Q
BCP54-10T-Q			BCP51-10T-Q
BCP54-16T-Q			BCP51-16T-Q

## 2. Features and benefits

- High collector current capability  $I_C$  and  $I_{CM}$
- Three current gain selections
- High power dissipation capability
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Linear voltage regulators
- MOSFET drivers
- High-side switches
- Power management
- Amplifiers

## 4. Quick reference data

Table 2. Quick reference data

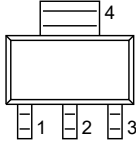
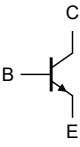
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{CEO}$	collector-emitter voltage	open base	-	-	45	V	
$I_C$	collector current		-	-	1	A	
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-	2	A	
$h_{FE}$	DC current gain						
	BCP54T-Q	$V_{CE} = 2\text{ V}; I_C = 150\text{ mA}$	[1]	63	-	250	
	BCP54-10T-Q		[1]	63	-	160	
	BCP54-16T-Q		[1]	100	-	250	

[1] pulsed;  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$

## 5. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base		 sym123
2	C	collector		
3	E	emitter		
4	C	collector		

## 6. Ordering information

Table 4. Ordering information

Type number	Package		Version
	Name	Description	
<a href="#">BCP54T-Q</a>	SC-73	plastic, surface-mounted package with increased heatsink; 4 leads	<a href="#">SOT223</a>
<a href="#">BCP54-10T-Q</a>			
<a href="#">BCP54-16T-Q</a>			

## 7. Marking

Table 5. Marking

Type number	Marking code
BCP54T-Q	BCP54T
BCP54-10T-Q	P5410T
BCP54-16T-Q	P5416T

## 8. Limiting values

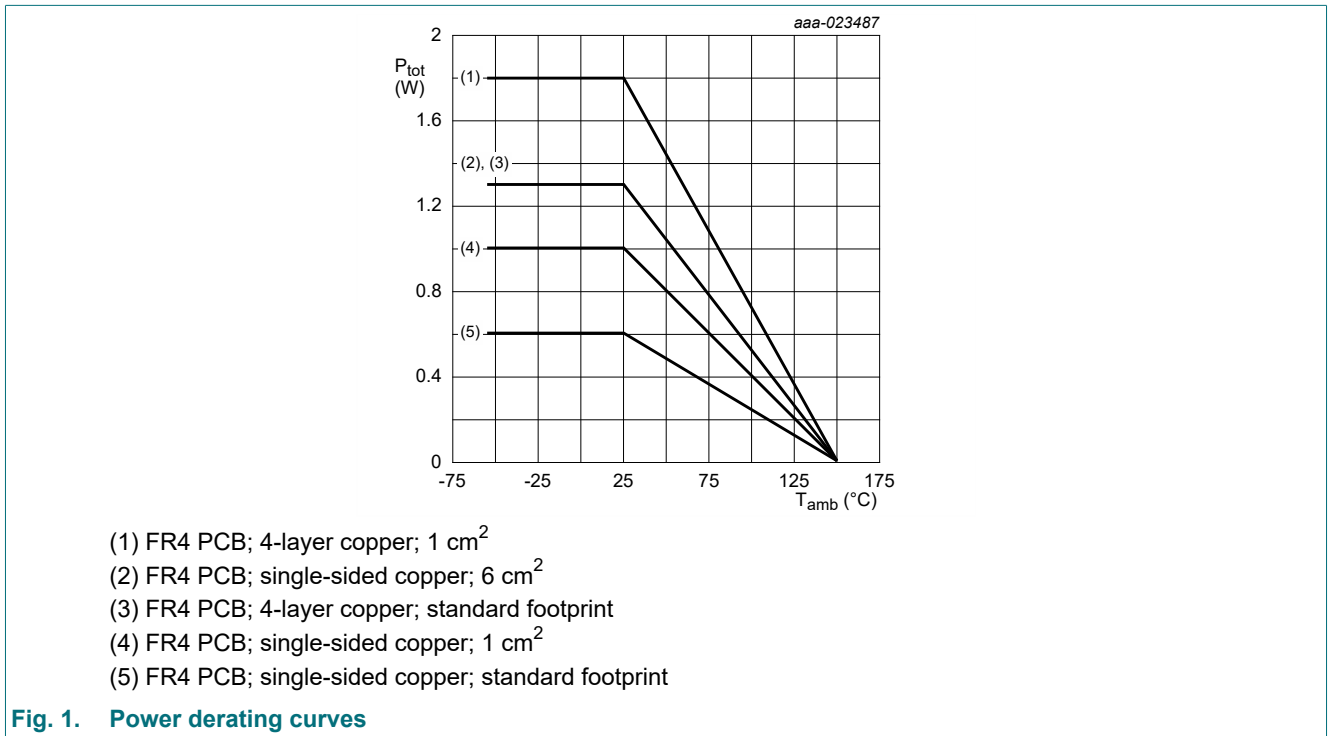
**Table 6. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

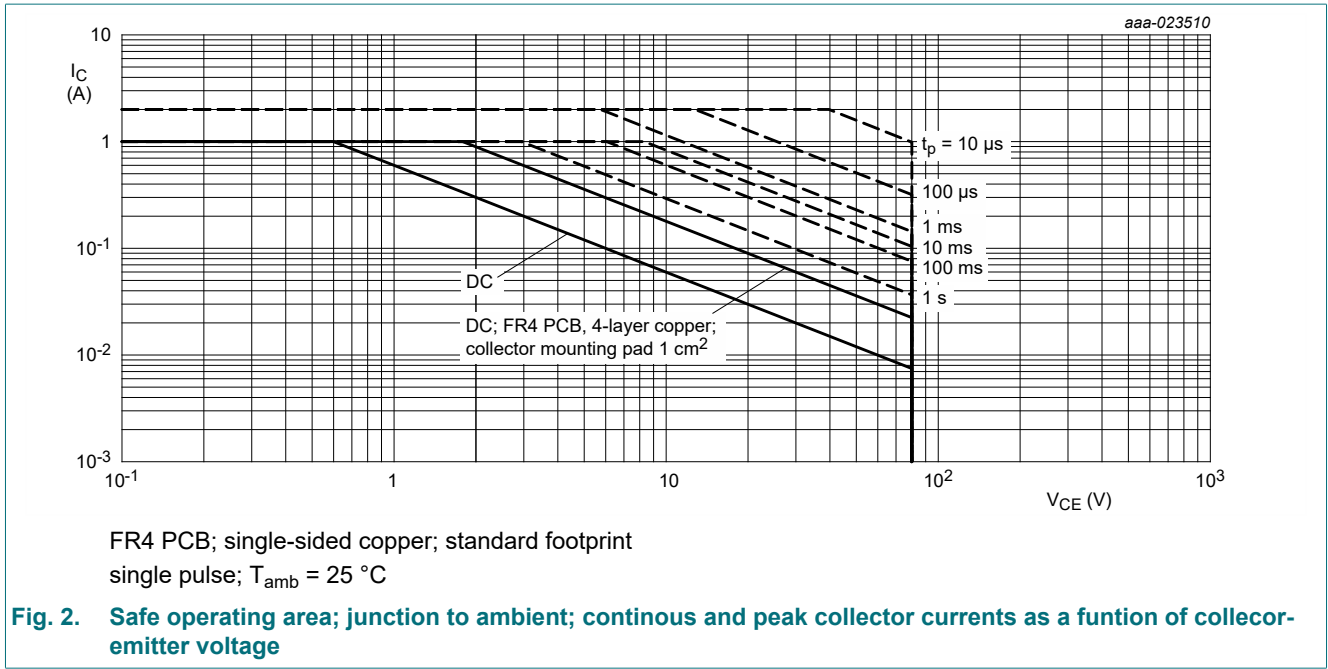
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	45	V
$V_{CEO}$	collector-emitter voltage	open base	-	45	V
$V_{EBO}$	emitter-base voltage	open collector	-	5	V
$I_C$	collector current		-	1	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	2	A
$I_B$	base current		-	0.2	A
$I_{BM}$	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	0.3	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	0.6	W
			[2]	1	W
			[3]	1.3	W
			[4]	1.3	W
			[5]	1.8	W
$T_j$	junction temperature		-	150	°C
$T_{amb}$	ambient temperature		-55	150	°C
$T_{stg}$	storage temperature		-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



**Fig. 1. Power derating curves**



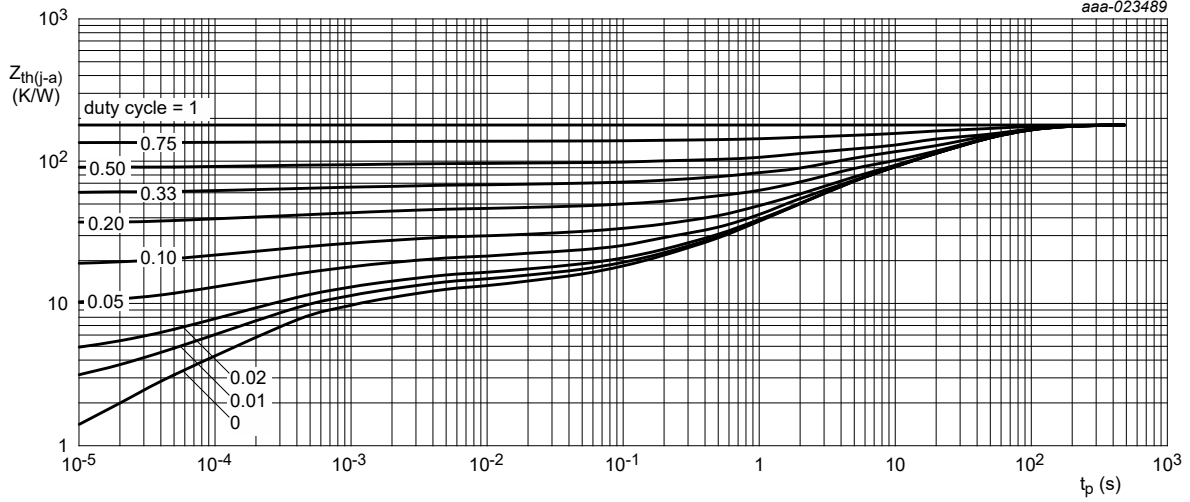
## 9. Thermal characteristics

**Table 7. Thermal characteristics**

$T_{amb} = 25\text{ °C}$  unless otherwise specified.

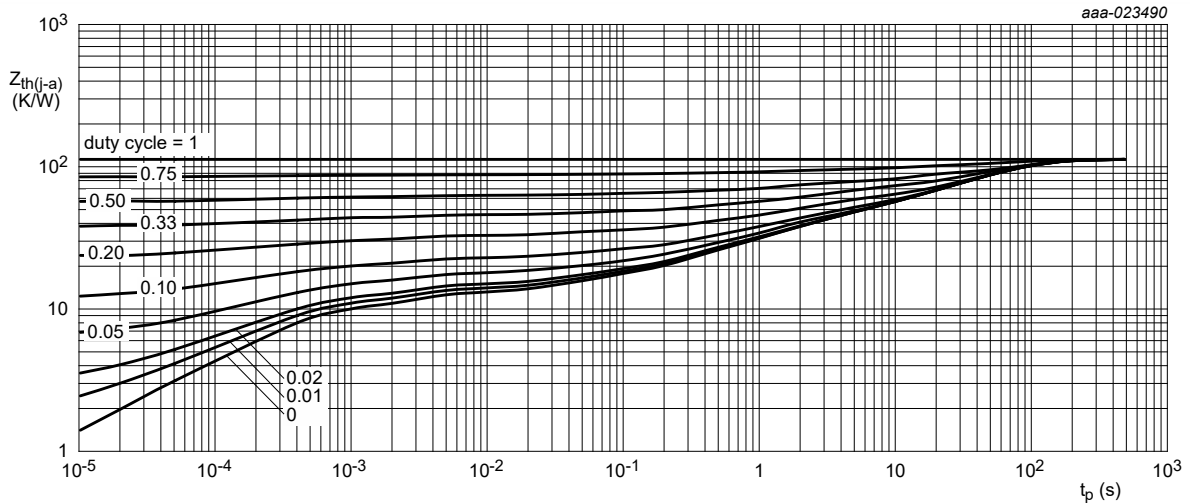
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	209	K/W
			[2]			125	K/W
			[3]			97	K/W
			[4]	-	-	97	K/W
			[5]	-	-	70	K/W
$R_{(j-sp)}$	thermal resistance from junction to solder point			-	-	18	K/W

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 Printed-Circuit-Board (PCB); 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



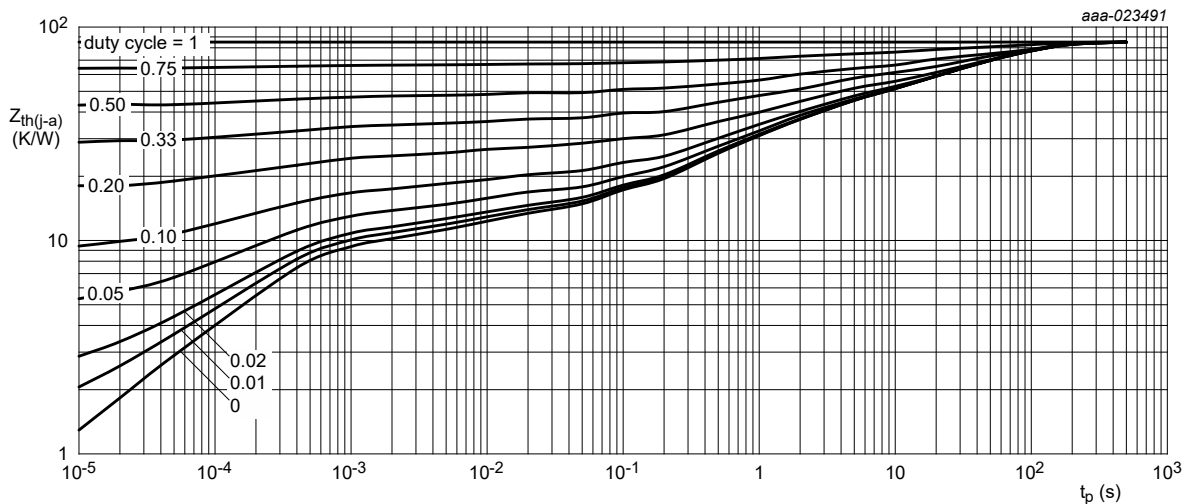
FR4 PCB; single-sided copper; tin-plated and standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



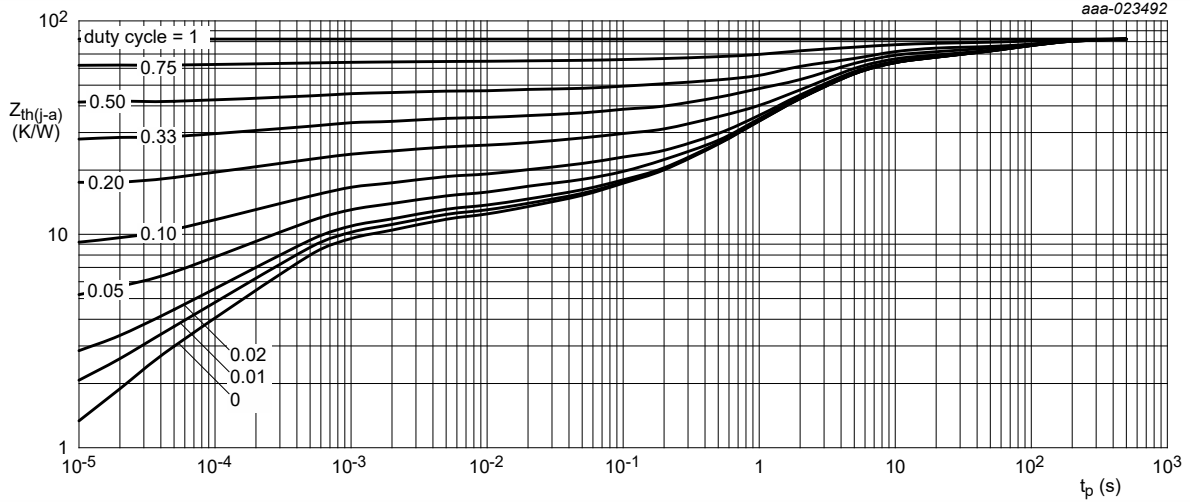
FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



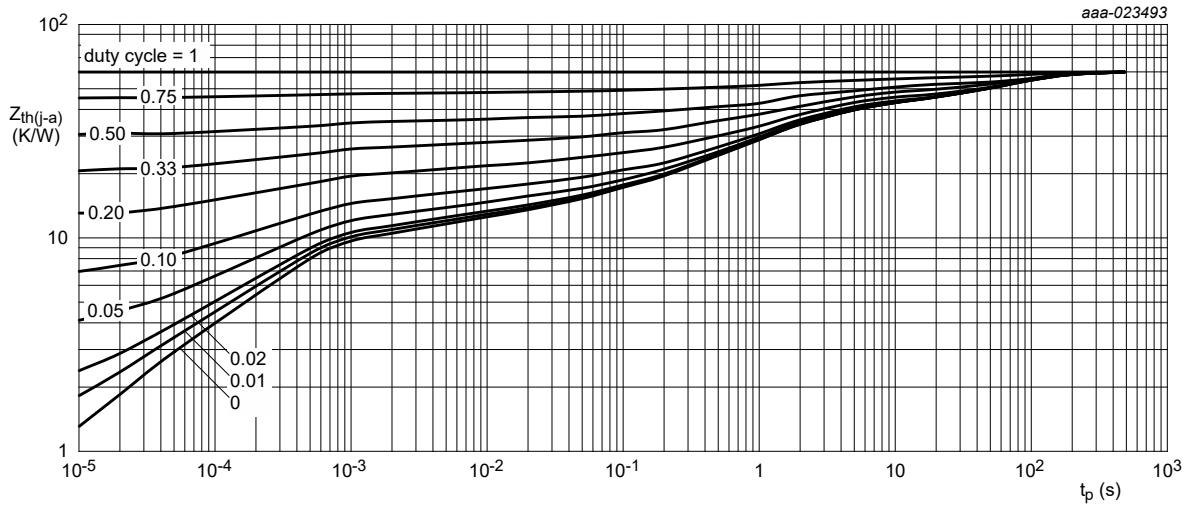
FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB; 4-layer copper; tin-plated and standard footprint

**Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>

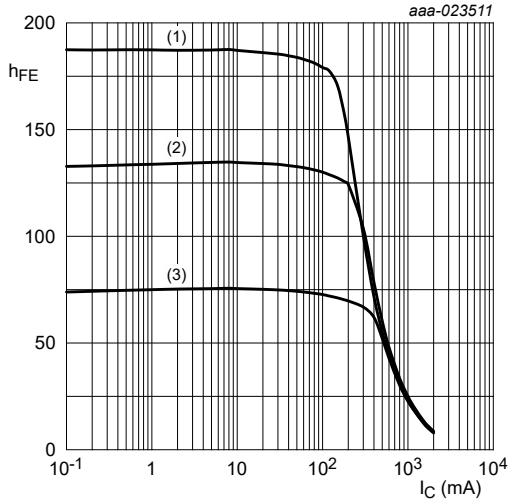
**Fig. 7. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**

## 10. Characteristics

**Table 8. Characteristics**
 $T_{amb} = 25\text{ °C}$  unless otherwise specified.

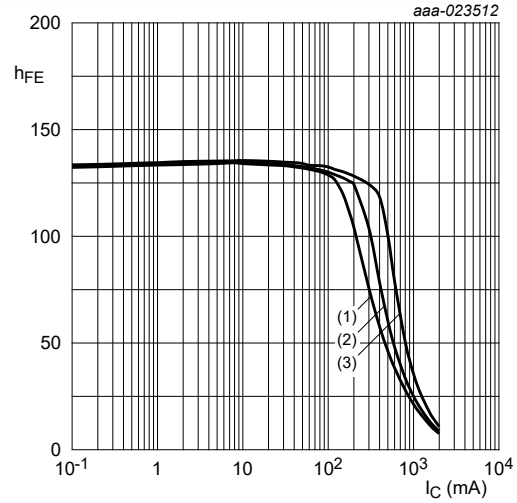
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100\ \mu\text{A}; I_E = 0\ \text{A}$	45	-	-	V	
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2\ \text{mA}; I_E = 0\ \text{A}$	45	-	-	V	
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 100\ \mu\text{A}; I_C = 0\ \text{A}$	5	-	-	V	
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 30\ \text{V}; I_E = 0\ \text{A}$	-	-	100	nA	
		$V_{CB} = 30\ \text{V}; I_E = 0\ \text{A}; T_J = 150\text{ °C}$	-	-	10	$\mu\text{A}$	
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5\ \text{V}; I_C = 0\ \text{A}$	-	-	100	nA	
$h_{FE}$	DC current gain						
	BCP54T-Q	$V_{CE} = 2\ \text{V}; I_C = 5\ \text{mA}$		63	-	-	
		$V_{CE} = 2\ \text{V}; I_C = 150\ \text{mA}$	[1]	63	-	250	
		$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	40	-	-	
	BCP54-10T-Q	$V_{CE} = 2\ \text{V}; I_C = 5\ \text{mA}$		63	-	-	
		$V_{CE} = 2\ \text{V}; I_C = 150\ \text{mA}$	[1]	63	-	160	
		$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	40	-	-	
	BCP54-16T-Q	$V_{CE} = 2\ \text{V}; I_C = 5\ \text{mA}$		63	-	-	
		$V_{CE} = 2\ \text{V}; I_C = 150\ \text{mA}$	[1]	100	-	250	
		$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	40	-	-	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 500\ \text{mA}; I_B = 50\ \text{mA}$	[1]	-	500	mV	
$V_{BE}$	base-emitter voltage	$V_{CE} = 2\ \text{V}; I_C = 500\ \text{mA}$	[1]	-	1	V	
$f_T$	transition frequency	$V_{CE} = 5\ \text{V}; I_C = 50\ \text{mA}; f = 100\ \text{MHz}$		100	155	-	MHz
$C_c$	collector capacitance	$V_{CB} = 10\ \text{V}; I_E = I_e = 0\ \text{A}; f = 1\ \text{MHz}$		-	4.5	-	pF

[1] pulsed;  $t_p \leq 300\ \mu\text{s}$ ;  $\delta \leq 0.02$



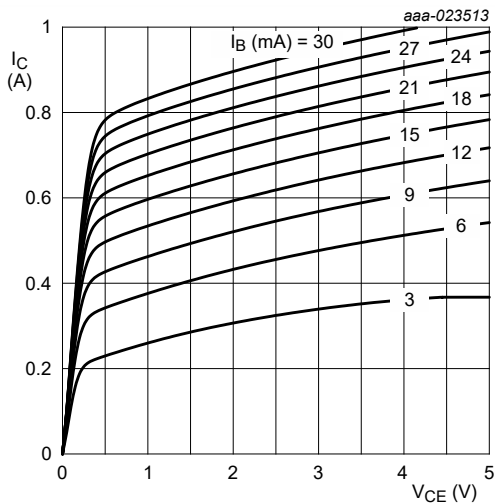
$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 8. DC current gain as a function of collector current; typical values**



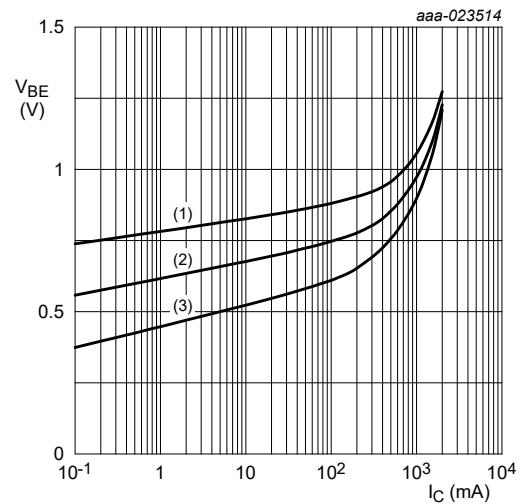
$T_{amb} = 25\text{ °C}$   
 (1)  $V_{CE} = 1\text{ V}$   
 (2)  $V_{CE} = 2\text{ V}$   
 (3)  $V_{CE} = 5\text{ V}$

**Fig. 9. DC current gain as a function of collector current; typical values**



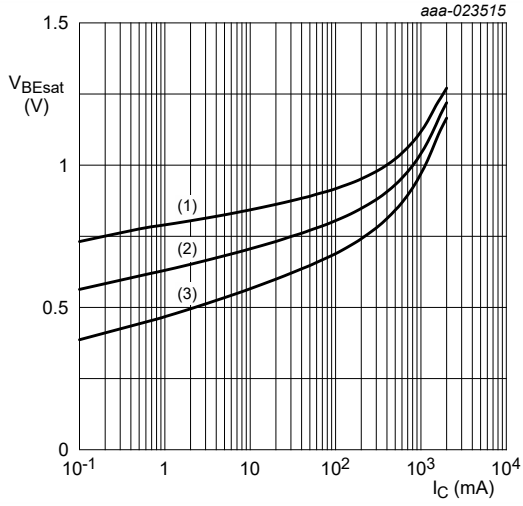
$T_{amb} = 25\text{ °C}$

**Fig. 10. Collector current as a function of collector-emitter voltage; typical values**



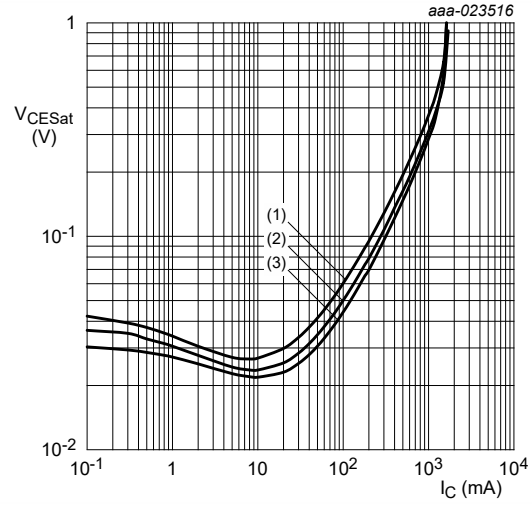
$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 11. Base-emitter voltage as a function of collector current; typical values**



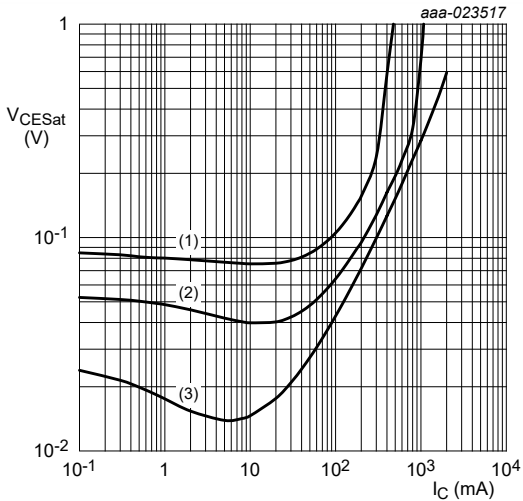
$I_C/I_B = 10$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 12. Base-emitter saturation voltage as a function of collector current; typical values**



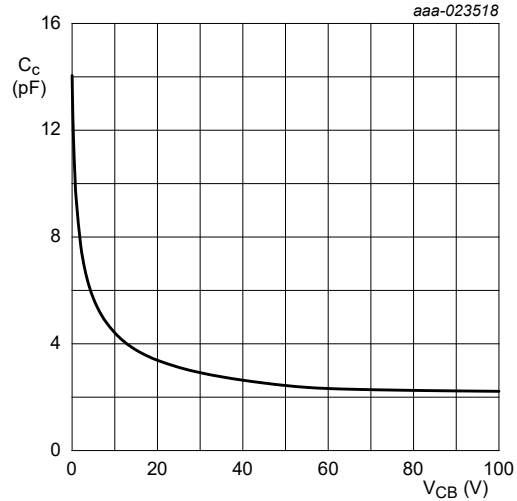
$I_C/I_B = 10$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 13. Collector-emitter saturation voltage as a function of collector current; typical values**



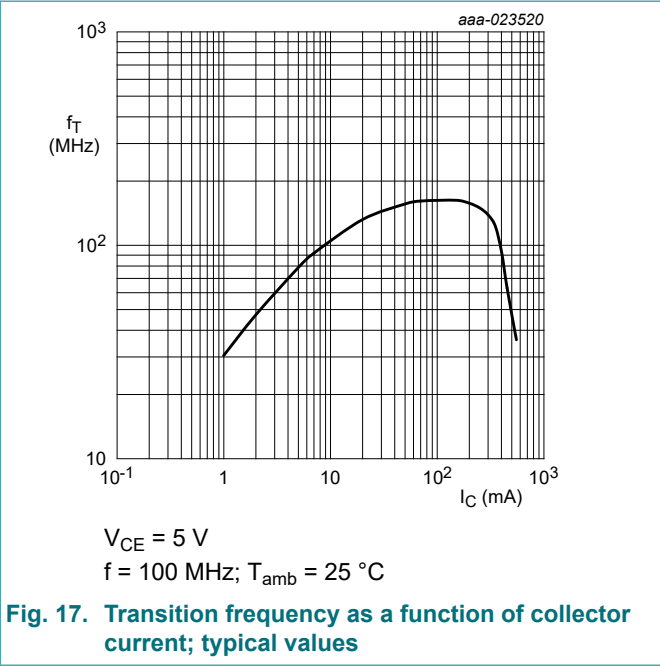
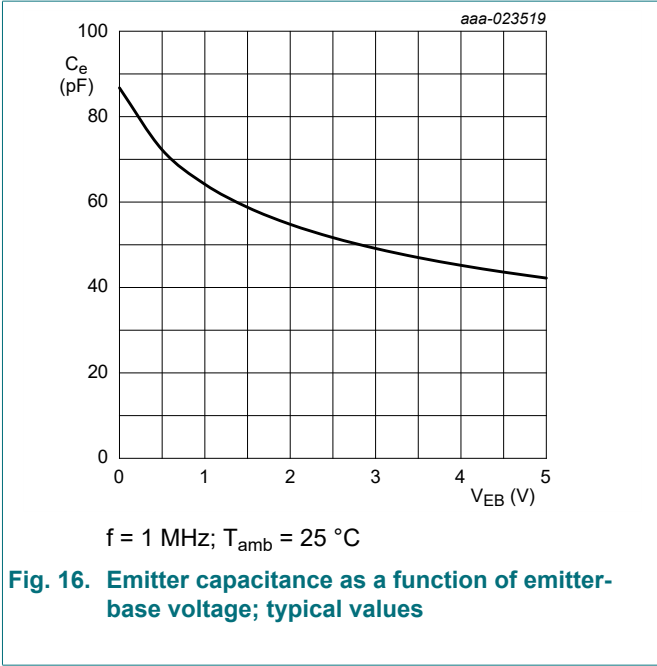
$T_{amb} = 25\text{ °C}$   
 (1)  $I_C/I_B = 50$   
 (2)  $I_C/I_B = 20$   
 (3)  $I_C/I_B = 5$

**Fig. 14. Collector-emitter saturation voltage as a function of collector current; typical values**



$f = 1\text{ MHz}; T_{amb} = 25\text{ °C}$

**Fig. 15. Collector capacitance as a function of collector-base voltage; typical values**

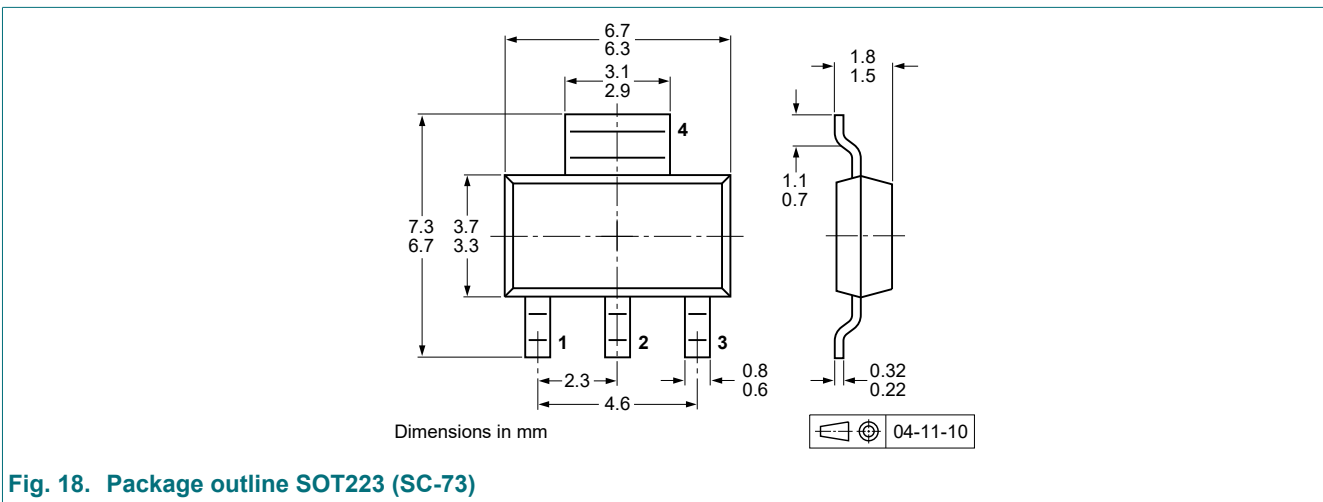


## 11. Test information

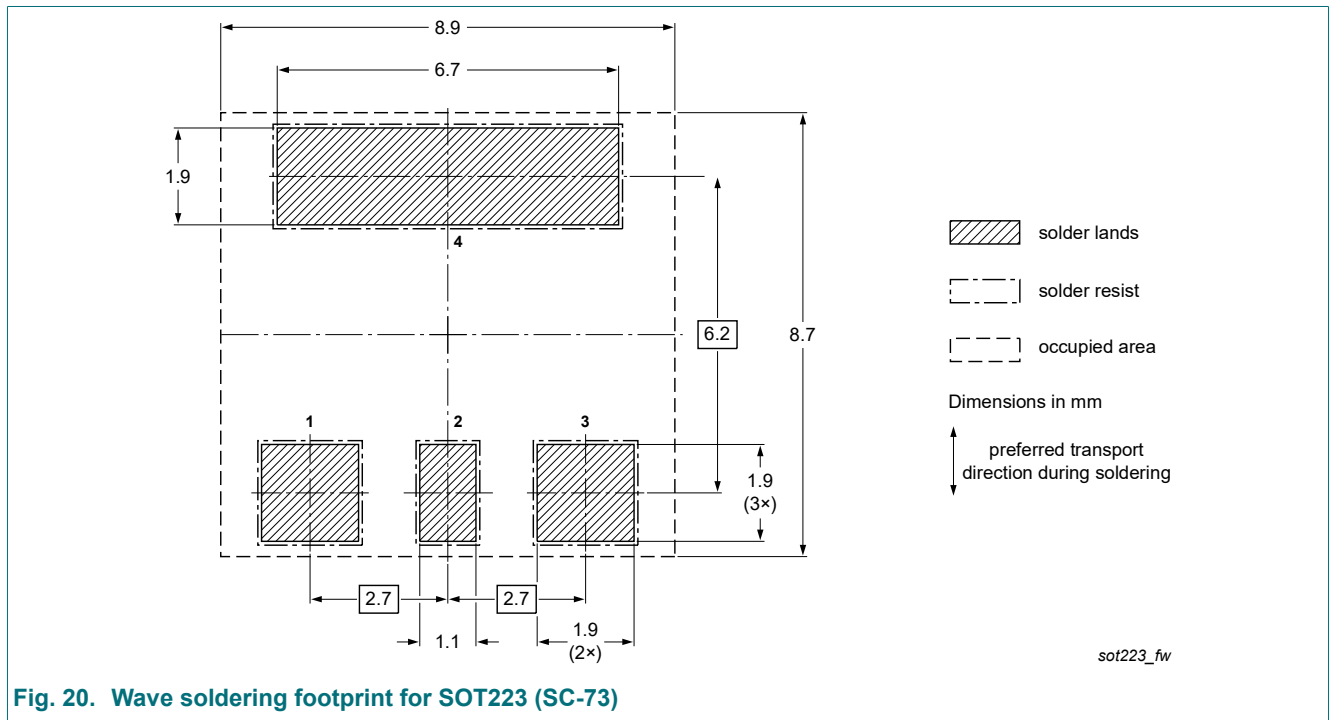
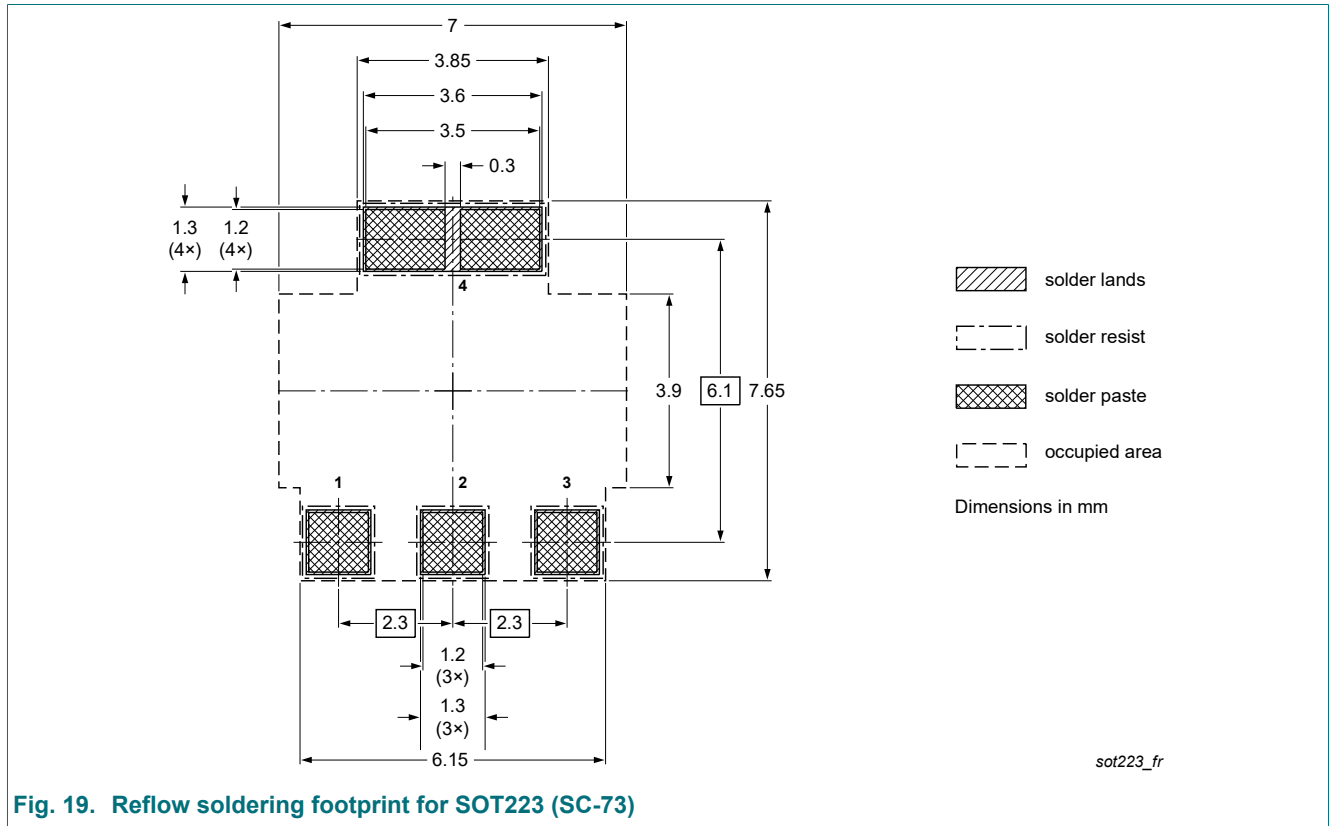
### 11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



### 13. Soldering



## 14. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCP54T-Q_SER v.1	2025114	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 14 November 2025

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